

Specifications

Insulation Resistance



SMD Comm X8G HT150C Flex, Ceramic, 3 pF, +/-0.5 pF, 200 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1210, 1.5 mm



General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	30 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1210
L	3.3mm +/-0.4mm
W	2.6mm +/-0.3mm
Т	0.78mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm

Capacitance 3 pF  Measurement Condition 1 MHz 1.0Vrms  Tolerance +/-0.5 pF  Voltage DC 200 VDC  Dielectric Withstanding Voltage 500 VDC  Temperature Range -55/+150°C  Temp. Coefficient X8G  Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)  Dissipation Factor 0.1% 1 MHz 1.0Vrms  Aging Rate 0% Loss/Decade Hour: Referee Time is 1000 Hours		
Tolerance +/-0.5 pF  Voltage DC 200 VDC  Dielectric Withstanding Voltage 500 VDC  Temperature Range -55/+150°C  Temp. Coefficient X8G  Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)  Dissipation Factor 0.1% 1 MHz 1.0Vrms  Aging Rate 0% Loss/Decade Hour: Referee	Capacitance	3 pF
Voltage DC  Dielectric Withstanding Voltage  Temperature Range  -55/+150°C  Temp. Coefficient  X8G  Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)  Dissipation Factor  Aging Rate  200 VDC  500 VDC  300 VDC  300 VDC  A8G  300 ppm/C, 1MegaHz 1.0Vrms  0.1% 1 MHz 1.0Vrms	Measurement Condition	1 MHz 1.0Vrms
Dielectric Withstanding Voltage 500 VDC  Temperature Range -55/+150°C  Temp. Coefficient X8G  Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)  Dissipation Factor 0.1% 1 MHz 1.0Vrms  Aging Rate 0% Loss/Decade Hour: Referee	Tolerance	+/-0.5 pF
Temperature Range -55/+150°C  Temp. Coefficient X8G  Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)  Dissipation Factor 0.1% 1 MHz 1.0Vrms  Aging Rate 0% Loss/Decade Hour: Referee	Voltage DC	200 VDC
Temp. Coefficient X8G  Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)  Dissipation Factor 0.1%1 MHz 1.0Vrms  Aging Rate 0% Loss/Decade Hour: Referee	Dielectric Withstanding Voltage	500 VDC
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)  Dissipation Factor  Aging Rate  30 ppm/C, 1MegaHz 1.0Vrms  0.1% 1 MHz 1.0Vrms  0% Loss/Decade Hour: Referee	Temperature Range	-55/+150°C
Reference to +25°C and 0 VDC Applied (TCC)  Dissipation Factor  O.1%1 MHz 1.0Vrms  Aging Rate  O% Loss/Decade Hour: Referee	Temp. Coefficient	X8G
Aging Rate O% Loss/Decade Hour: Referee	Reference to +25°C and 0 VDC	30 ppm/C, 1MegaHz 1.0Vrms
	Dissipation Factor	0.1% 1 MHz 1.0Vrms
	Aging Rate	

100 GOhms

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	10000

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